HITACHI

BE-IR30 / 31

Infrared B/W Camera Module Operation Guide

Please read this operation Guide carefully for proper operation, and keep it for future refernce.

Hitachi Kokusai Electric Inc.

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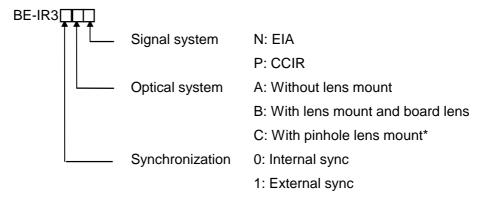
1. Introduction

Thank you very much for your purchase of the Hitachi BE-IR30/31 Black and White Camera Module.

Prior to using this camera, read this manual carefully.

2. General

The BE-IR30/31 is a monochrome camera module featuring sensitivity in the near infrared spectrum using a 1/3-inch size CCD imaging device. Resolution is outstanding, while the very small size provides optimum suitability for incorporation into equipment where space is limited. Model coding



^{*}Type C is mount only. Specify at time of order when requiring pinhole lens, CS or C mount adapter

3. Composition

- 1) Black and white camera module · · · · · · · 1
- 2) Interface cable · · · · · · 1

Note: The standard accessory cable is 300 mm signal conductor.

Different length cable requires shielding to avoid external noise.

4. Specifications

1) Imaging device 1/3 inch interline CCD No. of pixels EIA: $811(H) \times 508(V)$ CCIR: $795(H) \times 596(V)$

No. of effective pixels EIA: $768(H) \times 494(V)$

CCIR: 752(H) × 582

Pixel pitch EIA: $6.35(H) \times 7.4(v) \mu m$

CCIR: $6.5(H) \times 6.25(V) \mu m$

Specifications

2) Sensing area EIA: $6.00(H) \times 4.96(V)$ mm

CCIR: $6.00(H) \times 4.96(V)$ mm

3) Signal format Conforming to EIA or CCIR.

4) Scanning system 2:1 interlaced

5) Hor. scanning frequency EIA: 15.734 kHz

CCIR: 15.625 kHz

6) Vert. scanning frequency EIA: 59.94 Hz

CCIR: 50 Hz

7) Sync system BE-IR30: Internal sync

BE-IR31: External sync

8) External sync input HD & VD: 5V peak-to-peak negative

Input impedance: $1k\Omega$

Frequency deviation: ±1%

9) Video output 1.0 Vp-p, 75Ω, unbalanced

Video component: 0.7 Vp-p

Sync component: 0.3 Vp-p negative

10) Resolution EIA: $570(H) \times 380(V)$ TV lines

CCIR: 560(H) x 380(V) TV lines

11) Signal to noise ratio 56 dB

12) Auto electronic shutter Provided (factory setting OFF)

13) Automatic gain control (AGC) Max. 32 dB approx. Fixed gain(factory setting)

14) Integration mode Field integration mode

15) Gamma correction 0.45

0.45ON (factory setting) or 1.0

Selected by changing chip parts

16) Sensitivity 30 lux, F4, 3200k

17) Minimum illumination 0.3 lux , F1.4 , AGC and gamma on

18) Power supply voltage $9 \pm 0.5 \text{ VDC}$

19) Power consumption Approx. 150mA

20) Ambient conditions Operating: -5 to 45 , 90% RH or less

Storage: -10 to 60 , 70% RH or less

21) Standard lens

f3.8 (BE-IR30B/31B only)

Focal distance	3.8 mm	
F value	2.0	
Picture angle	Н	70.9
	٧	52.9

21) Dimensions

BE-IR30A/31A: 34 (W) \times 34 (H) \times 20 (D) mm

BE-IR30B/31B: 34 (W) \times 34 (H) \times 32 (D) mm

(less lens)

BE-IR30C/31C: 34 (W) \times 34 (H) \times 24 (D) mm

BE-IR30A/31A: Approx. 15g (less cable) 22) Mass

BE-IR30B/31B: Approx. 26g (including cable, less lens)

BE-IR30C/31C: Approx. 19g (less cable)

• BE-IR30A/31A mount adapter (LA-IR20)

23) Options

• BE-IR30B/31B lenses

Focal distance f (2.5	6.0				
F value	2.0	2.0				
Picture angle	Н	117.9	45.5			
	V	85.3	33.8			

BF-IR30C/31C pinhole lenses.

Focal distance f (3.2	3.7				
F value	4.5	4.5				
Picture angle	Н	90.6	72.6			
	V	56.9	54.2			

• BE-30C/31C CS mount adapter

BE-30C/31C C mount adapter

(use together with CS mount adapter)

NOTE

Auto electronic shutter

This is normally set to off at the factory.

If using a board lens (type B or C), the auto electronic shutter can be supplied from the factory at the on setting. Since changing the setting is somewhat troublesome (requires tools and technical skill for working with miniature parts) whenever possible, specify desired on or off setting at time of order.

Also note that certain types of lighting (e.g., fluorescent or mercury vapor) may cause flicker to appear on the monitor screen due to effects of power line frequency.

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5. Notes to users

◆ Power supply

- Connect a 9V DC voltage (8.5 to 9.5V) from an external regulated DC power supply.
- Use a stable power supply without ripple and noise.
- Prior to turning on the power switch, check that the polarities of the power cable are correct, referring to the connection diagram (Page 11, 12)

◆ To protect CCD (sensor)

- Do not touch the glass surface of the CCD sensor to avoid deterioration in picture quality due to dirt and scratches.
- If the glass surface of the sensor should become dusty or dirty, remove dust or dirt
 carefully with a cotton-tipped applicator. Do not wipe the surface with dry cloth or
 paper tissue to avoid possible damage to the glass surface by static electricity.

Protection of camera

- Do not use or store the camera under direct sunlight, at a place exposed to rain or snow, or at a place where flammable or corrosive gas is present.
- When housing the camera in a camera case, use the utmost care regarding rise of internal temperature.

When casing the camera , the temperature normally rises by 10 to 20 , compared with the outside air temperature. The camera operates in the temperature range from -5 to 45 . If the camera is used or left in high temperature environment for hours , the life of the camera may be shortened.

- Do not drop the camera. Do not apply strong shock or vibration to the camera.
- Before connecting or disconnecting a connector, turn off the camera and be sure to hold connector body to connect or disconnect the connector.

Camera arrangement

Mutual interference noise can occur if multiple cameras are arranged in close proximity.
 Separate the cameras to the extent possible.

When camera units are installed directly into other equipment, external noise can prevent a normal picture. In such cases, shield the camera units.

The camera can be damaged by static electricity. Use ample care when installing and arranging.

◆ Auto electric shutter

 In regions using 50 Hz power line frequency, flicker can appear on the monitor screen from light sources such as fluorescent or mercury. In such cases, release the auto electronic shutter.

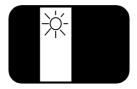
◆ Phenomena inherent to CCD imaging device

Following are phenomena inherent to a CCD imaging device, and not defects.

Smear and blooming

When strong light (lamp, fluorescent lamp, reflected light, etc.) is shot, pale bands are displayed vertically above and below the light.

In this case, change the angle of the camera so that such strong light does not enter the camera through the lens.



Fixed pattern noise

When the camera is operated in a high temperature, fixed pattern noise may appear on the entire screen.

The higher the sensitivity of camera, the more this fixed pattern noise appears.

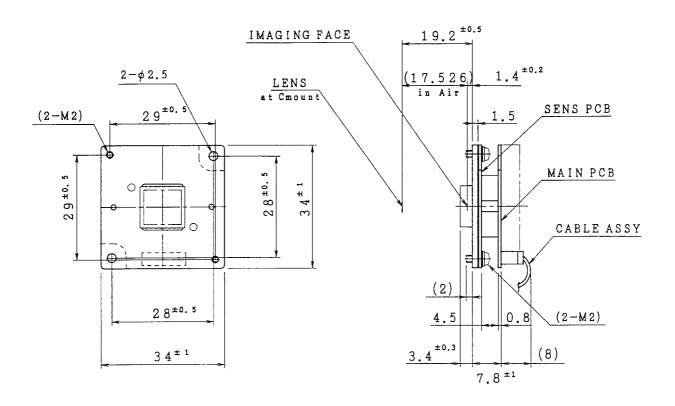
Moire

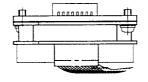
When fine patterns are shot, moire may be displayed.

 The CE mark is required when exporting to Europe. Obtain the necessary authorization for the customer's system. Enclose the camera in a shielded case and use shielded cable.

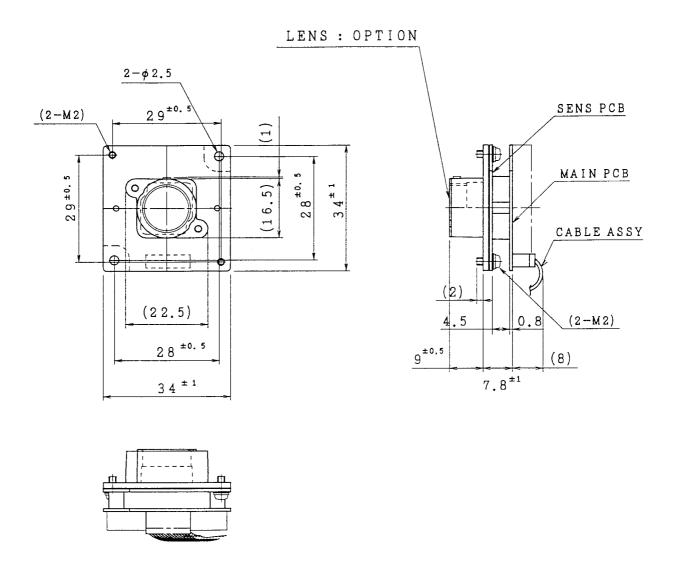
6. External view

BE-IR30B/31B

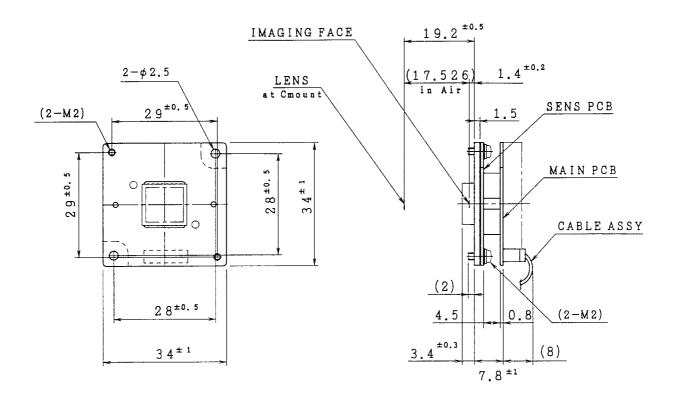


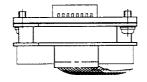


BE-IR30C/31C

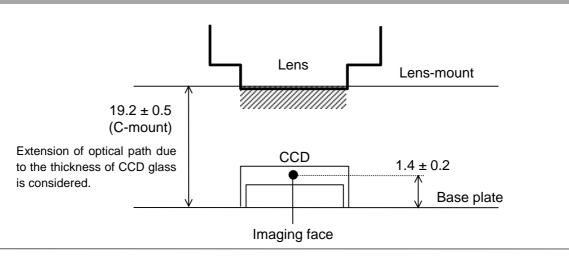


BE-IR30A/31A





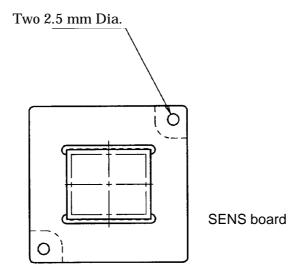
7. Optical dimensions



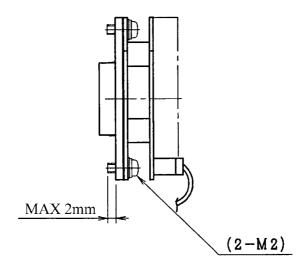
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8. Installation

When installing the camera in a housing or unit of equipment, secure with two M2 screws inserted into the 2.5 mm diameters holes of the SENS board base plate.

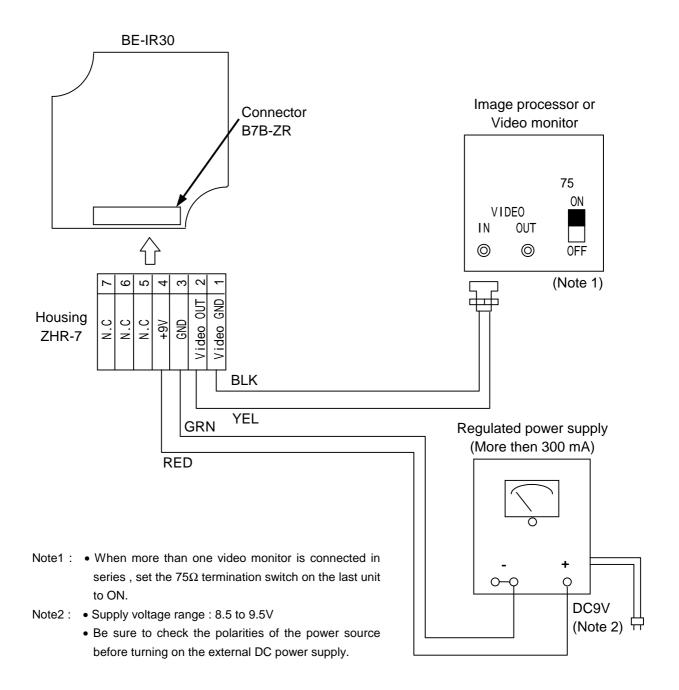


- Use the SENS board holds to install the camera. Avoid using only the Main board,
 Notes: due to risk of damage to the board connector.
 - 2. Avoid unnecessary stress on the printed board when engaging and disengaging the connectors.
 - The screws securing the base plate and SENS board protrude a maximum of 2 mm from the base plate. Observe these screws do not contact the housing or installed equipment.

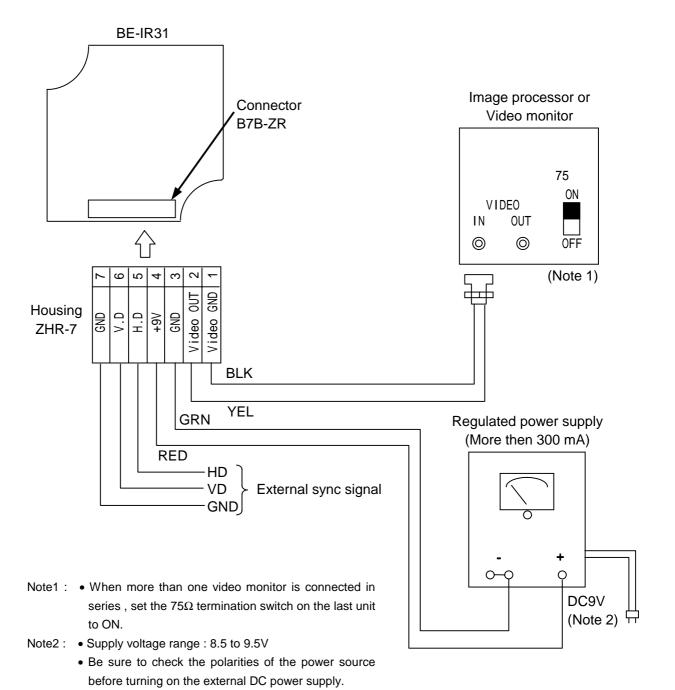


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9. Typical connection



9. Typical connection



10. External sync (BE-IR31)

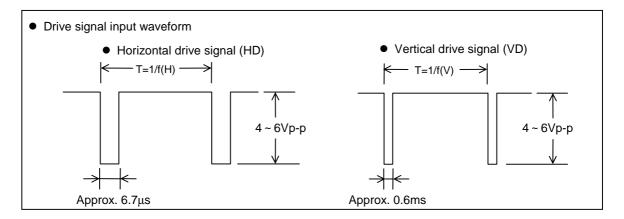
Supply sync signals (HD and VD) for BE-IR31 operation. Refer to connection on page 12.

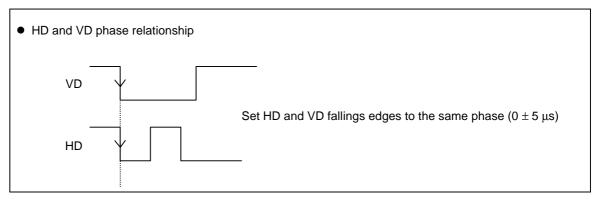
Horizontal and vertical drive signal inputs

HD EIA:
$$f(H) = 15.734 \text{ kHz } \pm 1 \%$$

VD EIA: $f(V) = 59.94 \text{ Hz } (f(V) = f(H) \div 262.5)$

- Input level
 - HD 4 to 6 Vp-p negative
 - VD 4 to 6 Vp-p negative
- Input impedance 1 k





11. Function setting and changes

When changing the function settings, perform the work with thorough care. Be sure to use anti-static measures such as a grounding band. Also observe safety precautions when soldering to avoid burn and fire hazards.

Hitachi Denshi assumes on liability for damage or injury resulting from such work.

Since the function setting can be provided at the time of shipment, consult a Hitachi Denshi representative.

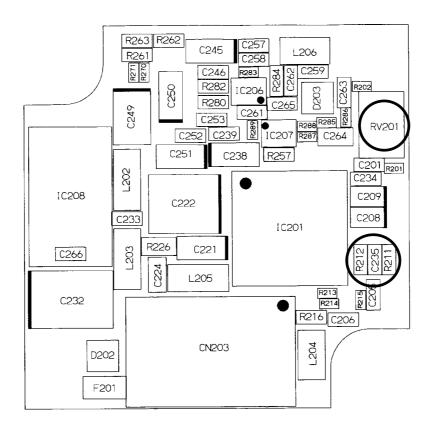
11-1 AGC on / off

Factory setting is AGC off (fixed gain). If necessary in the application, AGC can be set to on. When the AGC is off, the gain can be changed by turning RV201.

Set AGC on by changing the indicated chip parts.

Gain	R211	R212
fixed gain	Ω	Absent
AGC	Remove	0Ω

Factory setting



Location of chip resistor (Main board side A)

11-2 Gamma response

The factory setting is gamma on. If necessary, the gamma response can be changed as follows.

Change the gamma response by changing the chip part.

Gamma(γ)response	R217	R218	R219
ON	Absent	0Ω	Ω 0
OFF	0Ω	Remove	Remove

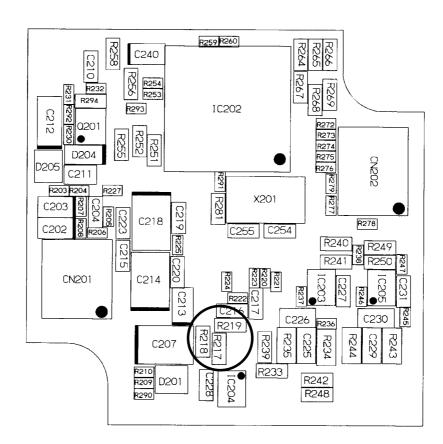
Factory setting

 0Ω : Part code

RME1784

Description

ERJ3GEYJ0R00V



Location of chip capacitors (Main board side B)

BE-IR30/31

11-3 Auto electronic shutter on / off

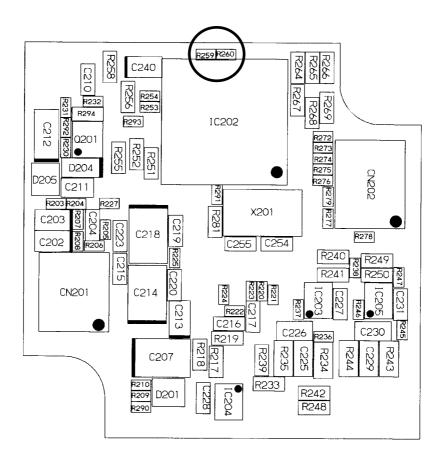
Factory setting for auto electronic shutter is off. If necessary, it can be set to on. Absent the R259, R260 chip to set the auto electronic shutter to on.

Auto electronic shutter	R259	R260
OFF	0Ω	0Ω
ON	Absent	Absent

Factory setting

 0Ω : Part code RME2068

Description ERJ2GE0R00X



Location of chip resistors (Main board side B)

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11. Function setting and changes

11-4 Changes to fixed shutter mode

The fixed shutter mode can be changed by replacing the chip parts indicated below.

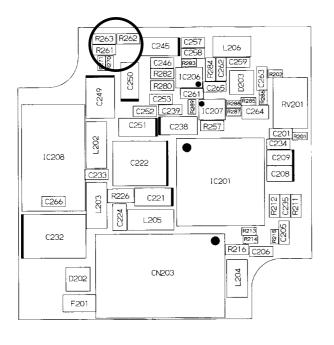
													Ī
	Mode	R259	R260	R261	R262	R263	R264	R265	R266	R267	R268	R269	
No	rmal mode	Ω0	0Ω	Absent	0Ω	Absent	6800	10k	27k	10k	10k	27k	Facto
	o electronic utter mode	Remove	Remove	Absent	0Ω	Absent							
Fi	EIA 1/100 CCIR 1/120	Remove	0Ω	0Ω	Remove	Absent	0Ω	0Ω	Remove	0Ω	0Ω	Remove	
Fixed	1/250									Remove	Remove	0Ω	
shutter	1/500			Absent	Remove	0Ω				0Ω	0Ω	Remove	
ter r	1/1000									Remove	Remove	0Ω	
mode	1/2000	1	^	0Ω	Remove	Absent	Remove	Remove	Ω0	0Ω	0Ω	Remove	
Ф	1/5000						1	1	Ω0	Remove	Remove	Ω0	
	1/10000			Absent	Remove	0Ω			0Ω	0Ω	0Ω	Remove	
	1/100000								Ω0	Remove	Remove	0Ω	

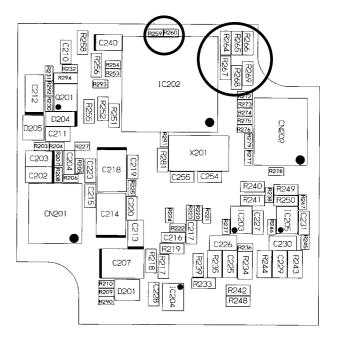
R259 , R260 : 0Ω Part code RME2068

Description ERJ2GE0R00X

Others : 0Ω Part code RME1784

Description ERJ3GEYJ0R00V





(Main board side A)

(Main board side B)

Location of chip resistors

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11-5 BE-IR30 external sync

The BE-IR30 factory setting is for internal sync. If required, this can be changed to external sync by changing chip parts.

Change the following chip parts for external sync operation.

Sync system	R280	R281	R282	R284
Internal	100 Ω	Absent	Absent	0 Ω
External	Delete	0 Ω	100 Ω	Delete

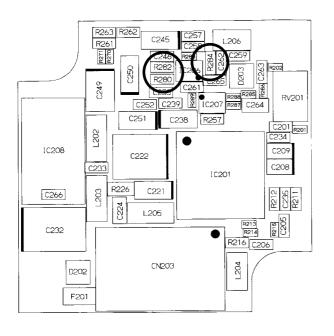
Factory setting

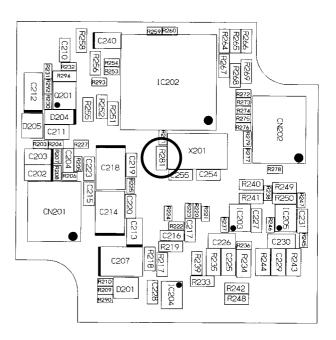
 0Ω : Part code RME1784

Type ERJ3GEYJ0R00V

100 Ω : Part code RME1797

Type ERJ3GEYJ101V





(Main board side A)

(Main board side B)

Location of chip resistors

11-6 BE-IR31 internal sync

The BE-IR31 factory setting is for external sync. If required, this can be changed to internal sync by changing chip parts.

Change the following chip parts for internal sync operation.

Sync system	R280	R281	R282	R284
External	Absent	0 Ω	100 Ω	Absent
Internal	100 Ω	Delete	Delete	0 Ω

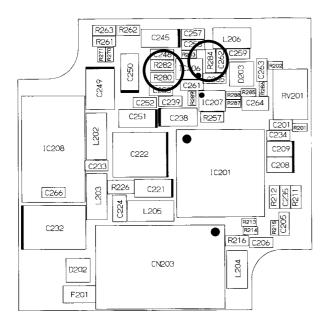
Factory setting

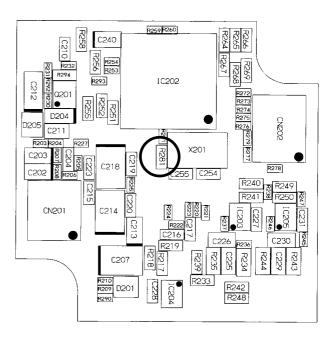
 0Ω : Part code RME1784

Type ERJ3GEYJ0R00V

100 Ω : Part code RME1797

Type ERJ3GEYJ101V





(Main board side A)

(Main board side B)

Location of chip resistors

11-7 HD and VD output (BE-IR30 only)

The BE-IR30 can be provided with horizontal and vertical drive outputs by changing chip parts. Change the following chip parts to provide HD and VD outputs.

	R233	R239	R240	R241	R242	R248	R249	R250
Factory setting	0 Ω	Absent						
HD & VD output	Delete	0 Ω						

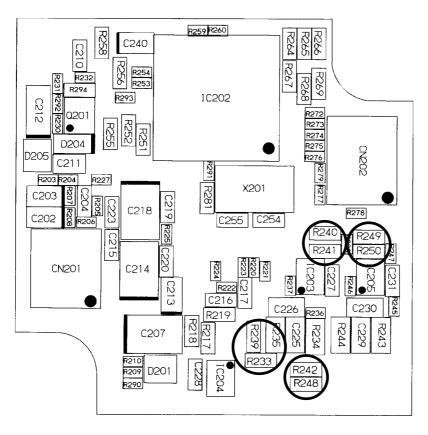
 0Ω : Pa

Part code

RME1784

Type

ERJ3GEYJ0R00V



Connector pin assignments after change

Pin No.	Signal
1	Video out
2	Video GND
3	GND
4	+9V
5	HD out
6	VD out
7	HD/VD GND

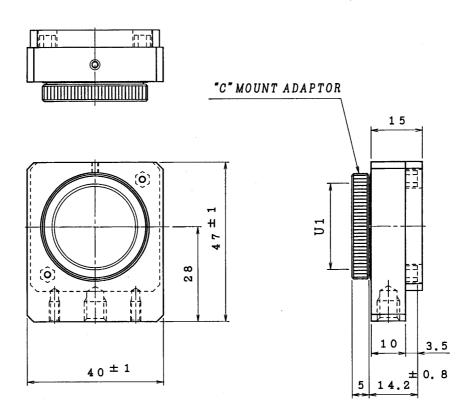
Note: The accessory cable cannot be used for signal outputs.

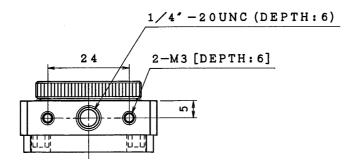
Location of chip resistors(Main board side B)

12. Options

LA-IR20 Mount adapter dimensions

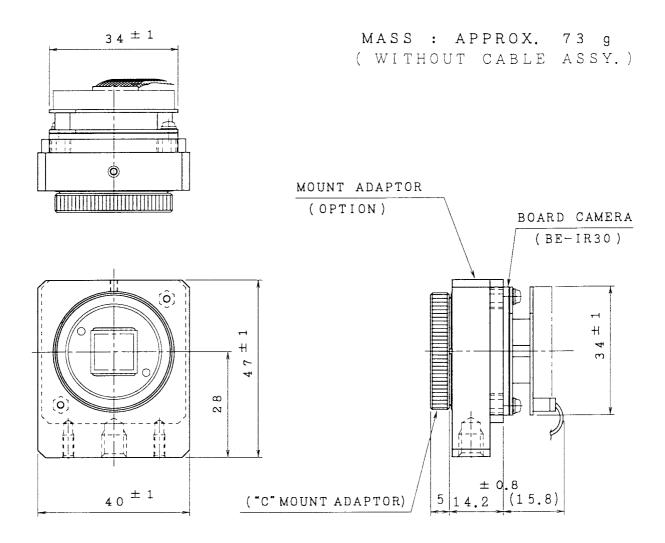
MASS: APPROX. 60 g

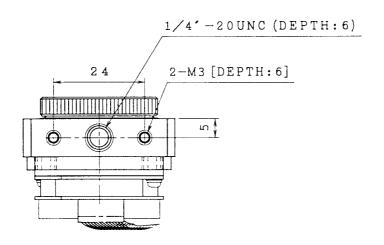




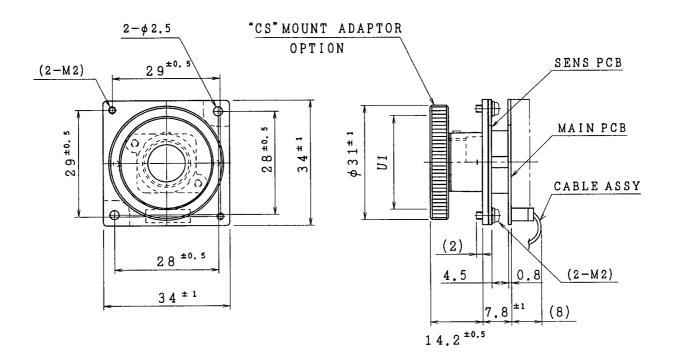
Remove c-mount attachment to use as cs-mount.

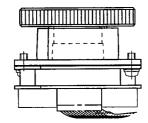
BE-IR30A/31A and LA-IR20 combined dimensions



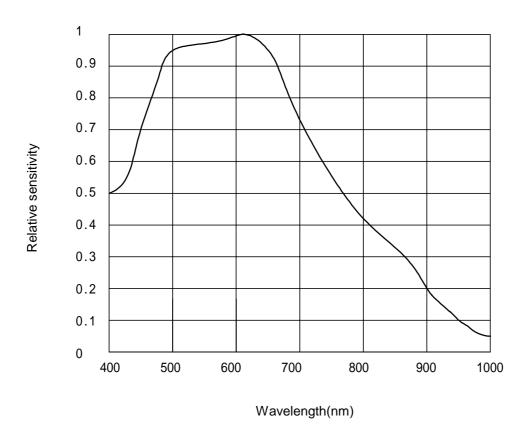


BE-IR30C/31C and CS mount adapter (option) combined dimensions





Spectral sensitivity (typical example)



Caution

The specifications of this equipment are subject to change without notice for improvement.

Prior to placing your order, be sure to confirm that these specifications are the latest ones.

Hitachi Denshi guarantee that the equipment shipped from our factory conforms to the Hitachi Denshi's standard warranty conditions and perform quality control within the range necessary to perform the warranty.

Warranty and After-sales Service

- (1) The guarantee period is one year after the date of purchase. However, the defects due to erroneous use or intentional act are excluded.
- (2) As the defect after expiration of the guarantee period, Hitachi Denshi will repair the equipment if the intended function is restored by the repair work, and the cost is changed to a customer.
- (3) Hitachi Denshi is not liable for the losses caused when the equipment is used in a system used for business trades, production process, medical fields, crime prevention applications, etc.
- (4) The parts used in the equipment have their respective lives. The lives of such parts will be shortened under the environments of high temperature or high humidity. When the stable operation is required for a long time, it is recommended to perform periodical maintenance and inspection every year or every two years.

Dec 27 2000

Jul 24 2000

Dec 9 1999

Aug 5 1999